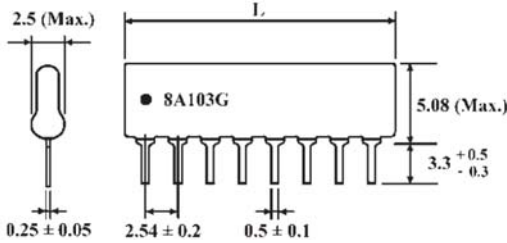


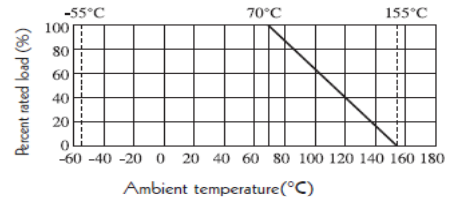
● 特性 Feature

- 小型高密度封装 Miniature, high density packaging
- 使用高稳定性RuO₂电阻材料 High reliability RuO₂ paste
- 良好的可焊性 Superior solderability

● 尺寸 Dimension



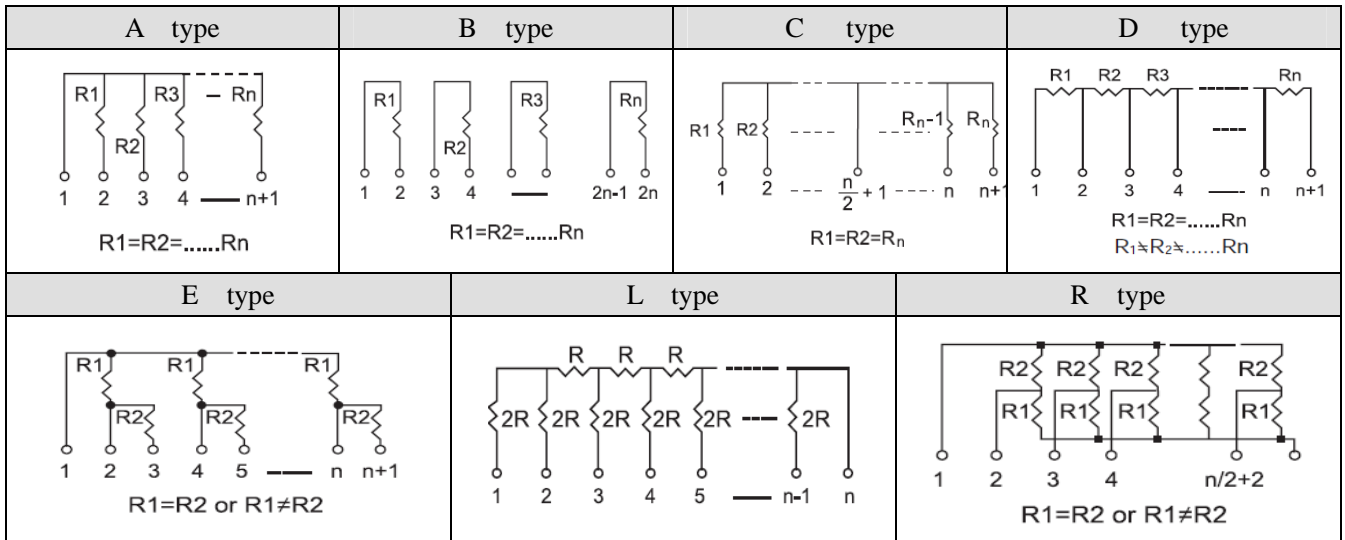
● 降功率曲线 Derating Curve



Dimension of L (Max.)

4 PIN : 10.2mm	10 PIN : 25.4mm
5 PIN : 12.7mm	11 PIN : 28.0mm
6 PIN : 15.3mm	12 PIN : 30.5mm
7 PIN : 17.8mm	13 PIN : 33.1mm
8 PIN : 20.4mm	14 PIN : 35.6mm
9 PIN : 22.9mm	

● 电路结构 Circuit Structure



● 性能 Specification

Type	Power rating (70°C)	Max. Working Voltage	Max. Overload Voltage	Dielectric withstanding Voltage	Resistance Range	Tolerance	Operating Temperature
B type	0.2W	100V	150V	200V	10Ω~1MΩ	±2% ±5%	-55°C~+155°C
R type	0.125W	100V	150V	200V	100Ω~10KΩ		
Others	0.125W	100V	150V	200V	10Ω~1MΩ		

● 标示 Marking

Single Value	8	A	102	G	Dual Value (R1/R2) (Ohm)
1st Pin	Total Pin	Circuit type	Resistance Value	Tolerance	160 / 240 330 / 390 330 / 470
Dual Value	8	A	330 / 470	G	180 / 390 220 / 270 220 / 330
1st Pin	Total Pin	Circuit type	Resistance Value	Tolerance	1.5K / 3.5K 3K / 6.2K

● 性能和测试要求 Specification And Test Methods

Temperature coefficient	50Ω ~ 1MΩ: ±200PPM/°C <50Ω & >1MΩ: ±250PPM/°C
Short-time overload	ΔR/R ≤ ±(0.5% + 0.1Ω)
Insulation resistance	Min. 10,000 Mega ohm.
Dielectric withstanding voltage	No Evidence of flashover, arcing or insulation breakdown
Terminal bending	ΔR/R ≤ ±(0.5% + 0.1Ω)
Load life	±(3.0% + 0.1Ω) Max.